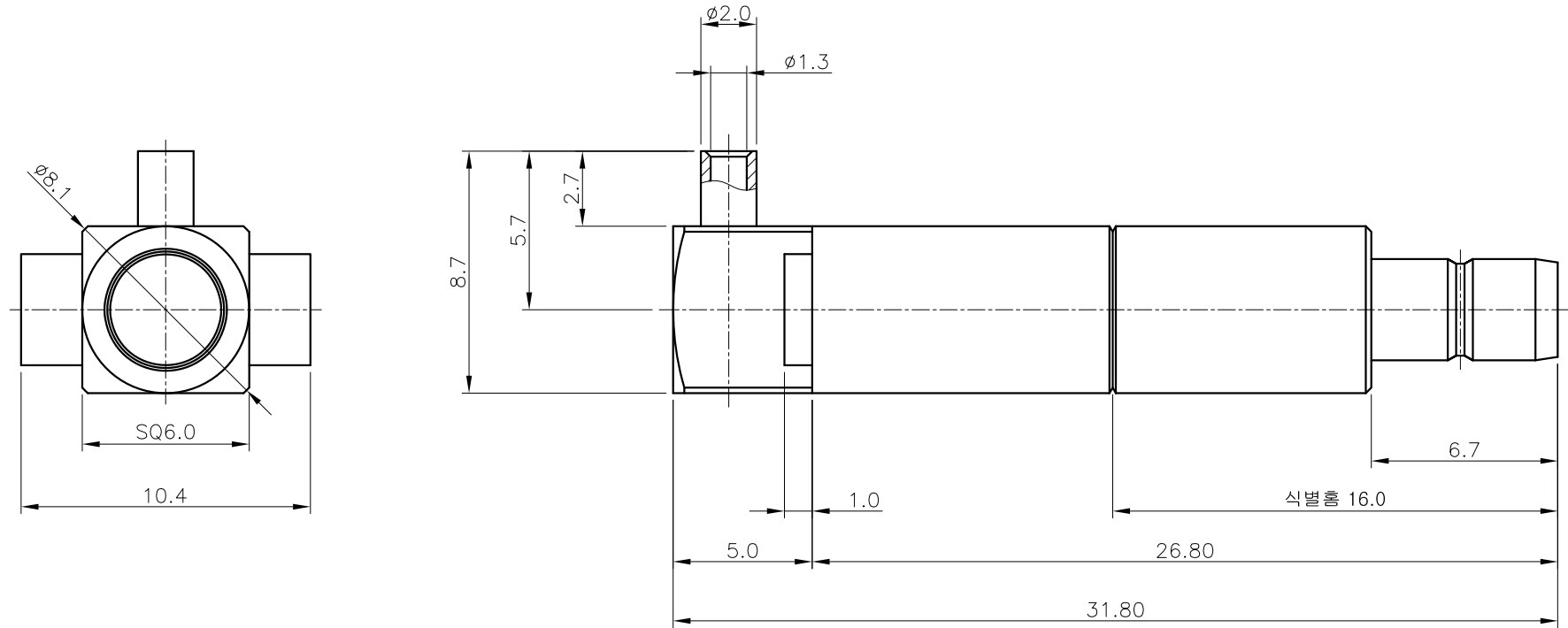


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2023.02.07.
1	절연COVER 코드 변경 - 역지끼움후 밀림 방지	S.H.KIM		2023.03.06.



6	COVER	1	MBsBD C3604BD-F	Nickel Plate (3 μ m)	DCO00017-5/4
5	INSULATOR	1	TEFLON		DIN02033-N/1 DIN00933-N/1
4	INSULATOR	1	TEFLON		DIN03340-N/1
3	INSULATOR	1	TEFLON		DIN02032-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate (0.4 μ m)	DCT04364-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate (5 μ m)	DBD04888-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 03. 06.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____		CHECKED BY			TITLE SMB50 CABLE JL 47 DH파노라마
		DRAWN BY S.H.KIM			
FINISH _____		SCALE 4/1	UNIT mm		A4
		DWG NO. CN04096-7/1			
		REVISION 1			SHEET 1 of 1